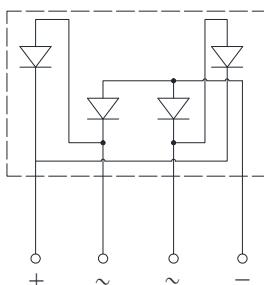
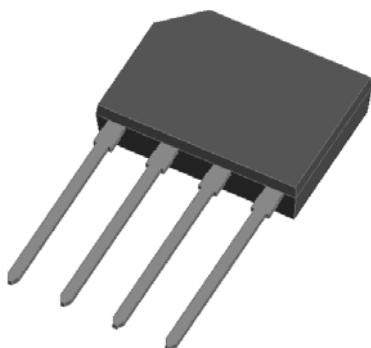


Low VF Bridge Rectifiers



Features

- UL recognition, file #E230084
- Glass passivated chip junction
- Low VF
- Ideal for printed circuit boards
- High surge current capability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.

Mechanical Data

- **Package:** GBP
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** As marked on body

■ Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	GBPL806
Device marking code			GBPL806
Maximum Repetitive Peak Reverse Voltage	VR _{RM}	V	600
Maximum RMS Voltage	VR _M S	V	420
Maximum DC blocking Voltage	V _{DC}	V	600
Average rectified output current @60Hz sine wave, R-load	With heatsink T _C =130°C Without heatsink T _a =25°C	IO A	8.0 1.8
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave, 1 cycle, T _j =25°C	I _{FSM}	A	170
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, T _j =25°C			340
Current squared time @1ms≤t≤8.3ms T _j =25°C, Rating of per diode	I ² t	A ² s	120
Dielectric strength @ terminals to case, AC 1 minute	V _{dis}	KV	2
Storage temperature	T _{stg}	°C	-55 ~ +150
Junction temperature	T _j	°C	-55 ~ +150



■ Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	GBPL806
Maximum instantaneous forward voltage drop per diode	VF	V	IFM=4.0A	0.92
Maximum DC reverse current at rated DC blocking voltage per diode	IR	μA	T _j =25°C	5
			T _j =125°C	100
Typical junction capacitance	C _j	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	58

■ Thermal Characteristics (Ta=25°C Unless otherwise specified)

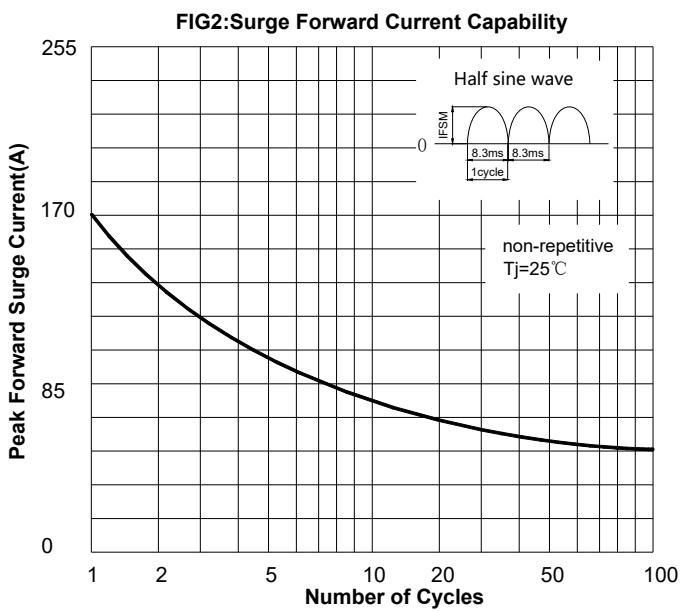
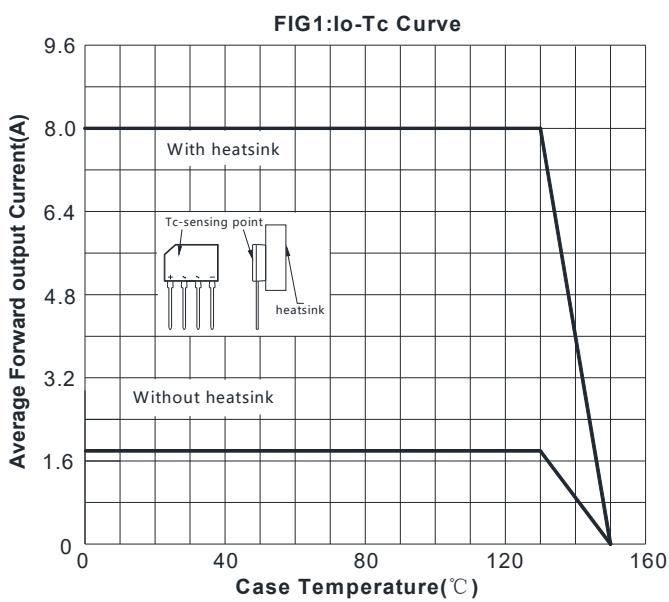
PARAMETER		SYMBOL	UNIT	GBPL806
Thermal Resistance	Between junction and ambient, Without heatsink	R _{θJ-A}	°C/W	45.0
	Between junction and case, With heatsink	R _{θJ-C}		1.5

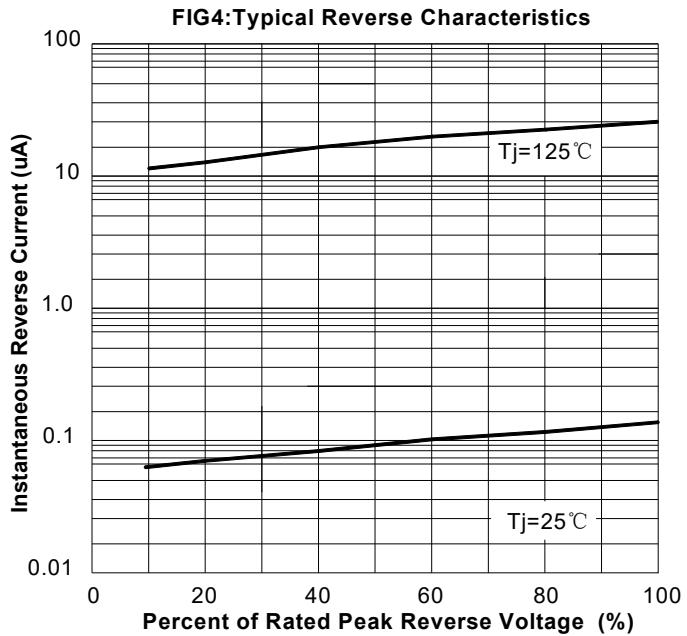
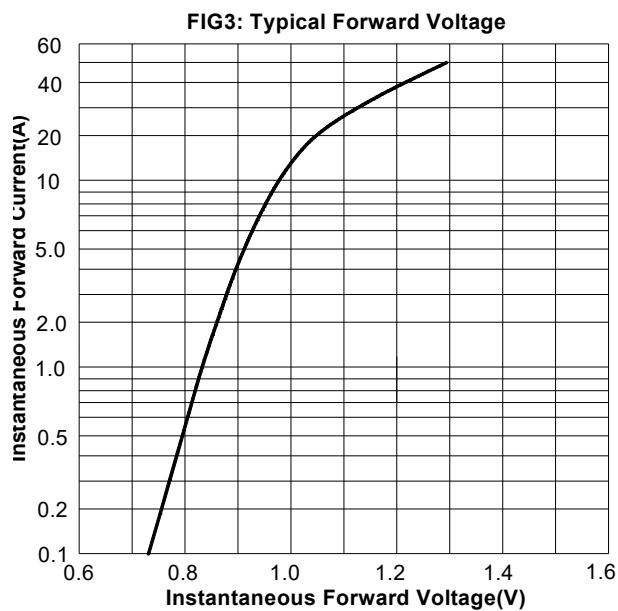
Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

■ Ordering Information (Example)

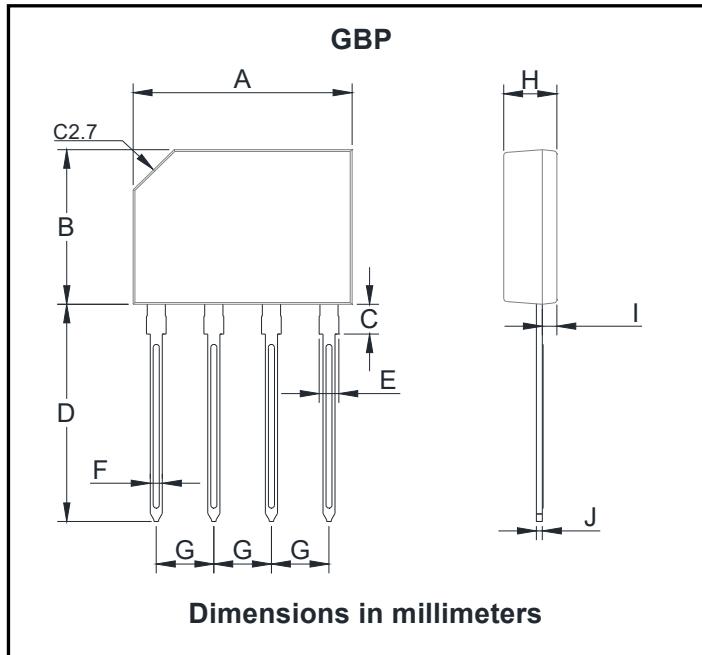
PREFERRED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GBPL806	B1	Approximate 1.4	35	2100	4200	TUBE

■ Characteristics (Typical)





■ Outline Dimensions



GBP		
Dim	Min	Max
A	14.25	14.75
B	10.10	10.60
C	1.80	2.20
D	14.25	14.73
E	1.22	1.42
F	0.76	0.86
G	3.70	3.90
H	3.35	3.65
I	0.80	1.10
J	0.35	0.55



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